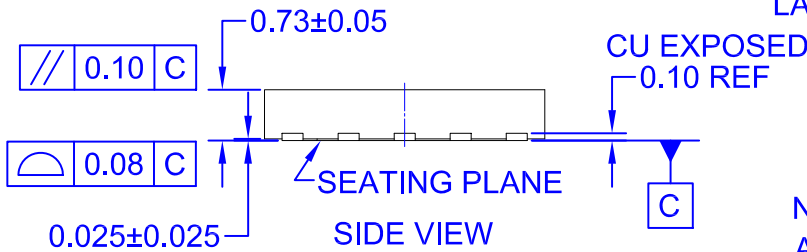
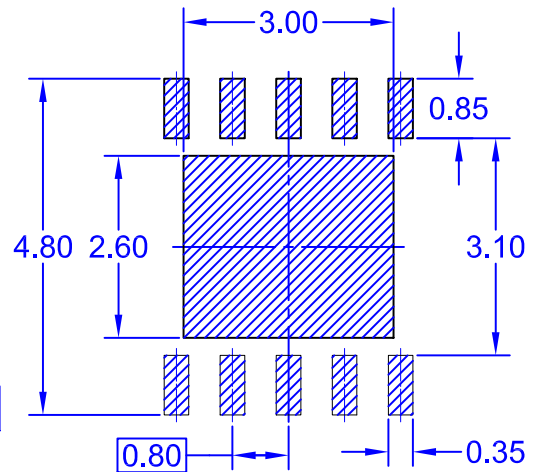
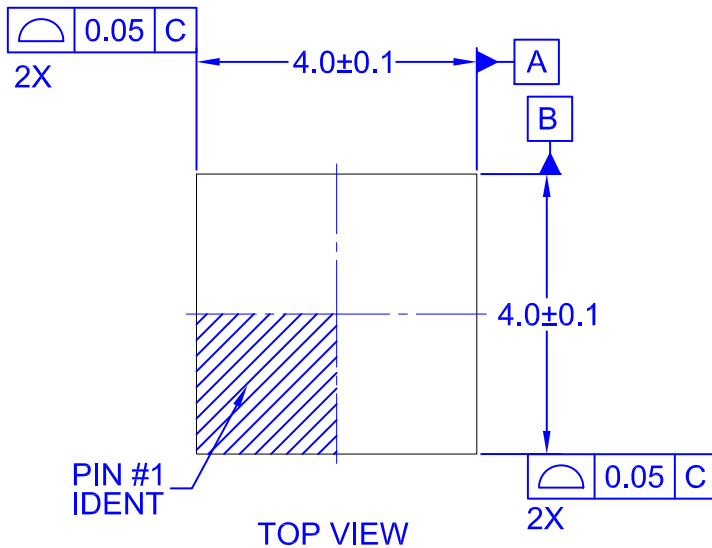




**WDFN10 4x4, 0.8P**  
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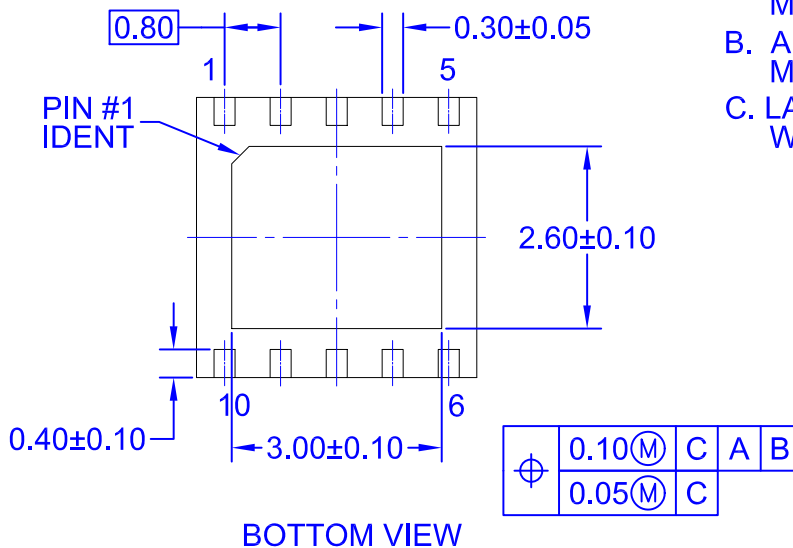
DATE 28 FEB 2017



LAND PATTERN RECOMMENDATION

NOTES:

- A. THIS PACKAGE DOES NOT FULLY CONFORM TO JEDEC MO-229, VARIATION VGGGB
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. LAND PATTERN IS FSC DESIGN WITH NOMINAL DIMENSIONS



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<b>DESCRIPTION:</b>	<b>WDFN10 4x4, 0.8P</b>	<b>PAGE 1 OF 1</b>

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